

## PATENT ASSIGNMENT

Electronic Version v07

Stylesheet Version v02

SUBMISSION TYPE:

NEW ASSIGNMENT

APPLICATION NUMBER

10/605324

NATURE OF CONVEYANCE:

ASSIGNMENT OF ASSIGNOR'S INTEREST

## CONVEYING PARTY DATA

Name	Execution Date
Chi-Kung Kuan	2003-09-23
Chao-Cheng Lee	2003-09-23
Kuan-Hua Lee	2003-09-23

## RECEIVING PARTY DATA

Name	Street Address	Internal Address	City	State/Country	Postal Code
Realtek Semiconductor Corp.	2 Industry E. Rd. IX, Science-Based Industrial	Park	Hsin-Chu Hsien	TAIWAN	

## CORRESPONDENCE DATA

FAX NUMBER: 886229295950

*Correspondence will be sent via US Mail when the fax attempt is unsuccessful.*

When the customer number has been provided, the Office of Public Records will obtain the correspondence data from the official record on file at the USPTO.

CUSTOMER NUMBER: 027765

NAME OF PERSON SIGNING:

WINSTON HSU

DATE SIGNED:

2003-09-23

Total Attachments: 2

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CH \$40.00 500801 10605324

## ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

### ASSIGNORS (Inventors):

Name: Chi-Kung Kuan Nationality: R.O.C.  
Address: No. 144, Alley 27, Lane 539, Chieh-Shou Rd., Ta-Hsi Town, Tao-Yuan Hsien, Taiwan, R.O.C.

Name: Chao-Cheng Lee Nationality: R.O.C.  
Address: No. 61-1, Lane 2, Shin-Sheng Rd., Jung-Li City, Tao-Yuan Hsien, Taiwan, R.O.C.

Name: Kuan-Hua Lee Nationality: R.O.C.  
Address: No. 39-3, Lane 2133, Chung-Hua 1st Rd., Ku-Shan, Kao-Hsiung City, Taiwan, R.O.C.

Hereby sells, assigns and transfers to Realtek Semiconductor Corp.  
(hereinafter 'Assignee'), of (Assignee address)

2 Industry E. Rd. IX, Science-Based Industrial Park  
, Hsin-Chu Hsien, Taiwan, R.O.C.

, and the successors assigns and legal representatives of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

"SYMMETRIC ELECTRICAL CONNECTION SYSTEM"

Which is found in :

- (a) \_\_\_\_\_ U.S. patent application executed on even date
- (b) \_\_\_\_\_ U.S. patent application executed on \_\_\_\_\_
- (c) \_\_\_\_\_ U.S. application serial no. \_\_\_\_\_
- (d) \_\_\_\_\_ patent no. \_\_\_\_\_ issued \_\_\_\_\_

and, in and to, all Letters Patent to be obtained for said invention by the above application or ant continuation, division, renewal, or substitute thereof, and as to letters patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this \_\_\_\_\_ (Date of signing).

(Type name of inventor)

**Signature of INVENTOR**

Chi-Kung Kuan

Chi-Kung Kuan

Chao-Cheng Lee

Chao - Cheng Lee

Kuan-Hua Lee

Kuan - Hua Lee